Preferred Device

Common Anode Silicon Dual Switching Diodes

These Common Anode Silicon Epitaxial Planar Dual Diodes are designed for use in ultra high speed switching applications. The DAP222 device is housed in the SC-75/SOT-416 package which is designed for low power surface mount applications, where board space is at a premium. The DAP202U device is housed in the SC-70/SOT-323 package.

Features

- Fast t_{rr}
- Low C_D
- Available in 8 mm Tape and Reel
- Pb–Free Package is Available

MAXIMUM RATINGS (T _A = 25°C	XIMUM RATINGS (T _A = 25°C)				
Rating	Symbol	Value	Unit		
Reverse Voltage	V _R	80	Vdc		
Peak Reverse Voltage	V _{RM}	80	Vdc		
Forward Current	Ι _F	100	mAdc		
Peak Forward Current	I _{FM}	300	mAdc		

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

I_{FSM}(1)

2.0

Adc

THERMAL CHARACTERISTICS

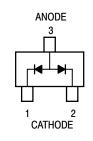
Peak Forward Surge Current

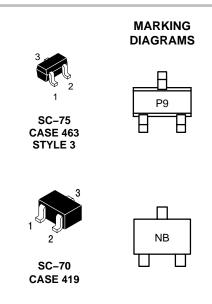
Rating	Symbol	Max	Unit
Power Dissipation	PD	150	mW
Junction Temperature	Τ _J	150	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C



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http://onsemi.com





ORDERING INFORMATION

Device	Package	Shipping [†]
DAP222	SC-75	3000/Tape & Reel
DAP202U	SC-70	3000/Tape & Reel
DAP222T1	SC-75	3000/Tape & Reel
DAP222T1G	SC–75 (Pb–Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Characteristic	Symbol	Condition	Min	Max	Unit
Reverse Voltage Leakage Current	I _R	V _R = 70 V		0.1	μAdc
Forward Voltage	VF	I _F = 100 mA	_	1.2	Vdc
Reverse Breakdown Voltage	V _R	I _R = 100 μA	80	_	Vdc
Diode Capacitance	CD	V _R = 6.0 V, f = 1.0 MHz	_	3.5	pF
Reverse Recovery Time DAP222 DAP202U	t _{rr} (2) t _{tt} (3)	$ I_F = 5.0 \text{ mA}, V_R = 6.0 \text{ V}, R_L = 100 \Omega, I_{rr} = 0.1 I_R \\ I_F = 5.0 \text{ mA}, V_R = 6.0 V, R_L = 50 \Omega, I_{rr} = 0.1 I_R $		4.0 10.0	ns

1. $t = 1 \mu S$ 2. t_{rr} Test Circuit for DAP222 in Figure 4. 3. trr Test Circuit for DAP202U in Figure 5.

TYPICAL ELECTRICAL CHARACTERISTICS

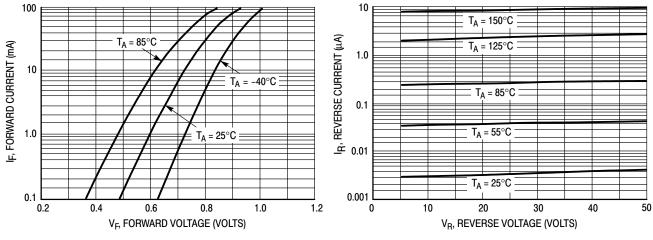


Figure 1. Forward Voltage

Figure 2. Reverse Current

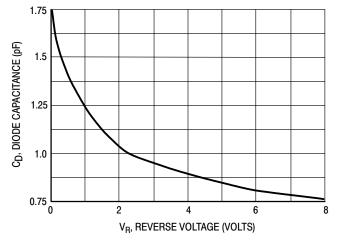
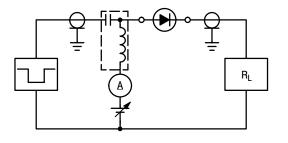
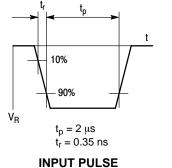
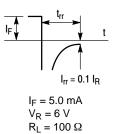


Figure 3. Diode Capacitance



RECOVERY TIME EQUIVALENT TEST CIRCUIT





OUTPUT PULSE

Figure 4. Reverse Recovery Time Test Circuit for the DAP222

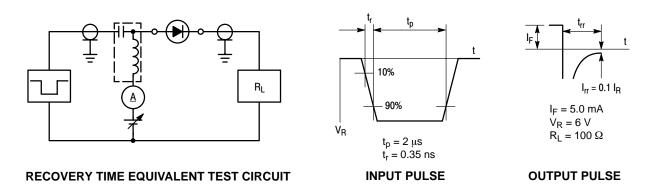
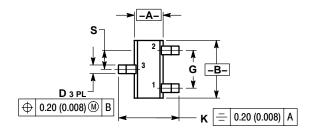
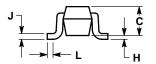


Figure 5. Reverse Recovery Time Test Circuit for the DAP202U

PACKAGE DIMENSIONS

SC-75 (SOT-416) CASE 463-01 ISSUE C





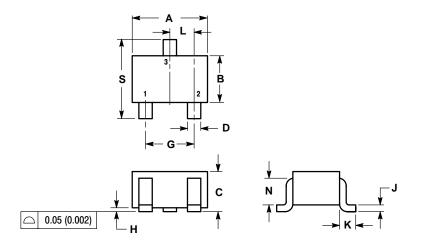
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROL LING DIMENSION: MILLIMETER.

CONTROLLING DIMENSION: MILLIMETER				
	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.70	0.90	0.028	0.035
в	1.40	1.80	0.055	0.071
С	0.60	0.90	0.024	0.035
D	0.15	0.30	0.006	0.012
G	1.00 BSC		0.039 BSC	
н		0.10		0.004
J	0.10	0.25	0.004	0.010
К	1.45	1.75	0.057	0.069
L	0.10	0.20	0.004	0.008
S	0.50 BSC		0.020	BSC

STYLE 3: PIN 1. ANODE 2. ANODE 3. CATHODE

PACKAGE DIMENSIONS

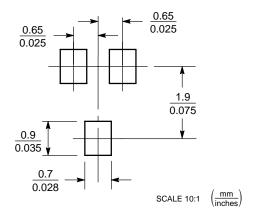
SC-70 (SOT-323) CASE 419-04 ISSUE L



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.032	0.040	0.80	1.00	
D	0.012	0.016	0.30	0.40	
G	0.047	0.055	1.20	1.40	
Н	0.000	0.004	0.00	0.10	
J	0.004	0.010	0.10	0.25	
K	0.017 REF		0.425	425 REF	
L	0.026 BSC		0.650	0 BSC	
Ν	0.028 REF		0.700	0.700 REF	
s	0.079	0.095	2.00	2.40	

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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